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**ON Semiconductor®** 

# FQP13N50C / FQPF13N50C N-Channel QFET<sup>®</sup> MOSFET

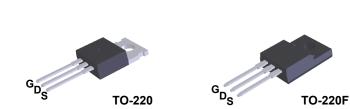
500 V, 13 A, 480 m  $\Omega$ 

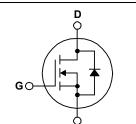
### Description

These N-Channel enhancement mode power field effect transistors are produced using ON Semiconductor's proprietary, planar stripe, DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switched mode power supplies, active power factor correction, electronic lamp ballasts based on half bridge topology.

#### Features

- + 13 A, 500 V,  $R_{DS(on)}$  = 480 m $\Omega$  (Max.) @  $V_{GS}$  = 10 V,  $I_{D}$  = 6.5 A
- Low Gate Charge (Typ. 43 nC)
- Low Crss (Typ. 20 pF)
- 100% Avalanche Tested





#### Absolute Maximum Ratings T<sub>c</sub> = 25°C unless otherwise noted.

Symbol	Parameter		FQP13N50C	FQPF13N50C	Units	
V <sub>DSS</sub>	Drain-Source Voltage	n-Source Voltage		500		
I <sub>D</sub>	Drain Current - Continuous (T <sub>C</sub> = 25°C	)	13	13 *	А	
	- Continuous (T <sub>C</sub> = 100°	8	8 *	А		
I <sub>DM</sub>	Drain Current - Pulsed	(Note 1)	52	52 *	А	
V <sub>GSS</sub>	Gate-Source Voltage		± 30		V	
E <sub>AS</sub>	Single Pulsed Avalanche Energy	(Note 2)	8	60	mJ	
I <sub>AR</sub>	Avalanche Current	(Note 1)		13	А	
E <sub>AR</sub>	Repetitive Avalanche Energy	(Note 1)	1	9.5	mJ	
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	4	.5	V/ns	
P <sub>D</sub>	Power Dissipation ( $T_C = 25^{\circ}C$ )		195	48	W	
	- Derate above 25°C	1.56	0.39	W/°C		
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150		°C	
TL	Maximum lead temperature for soldering p	300		°C		
	1/8" from case for 5 seconds	3	500			

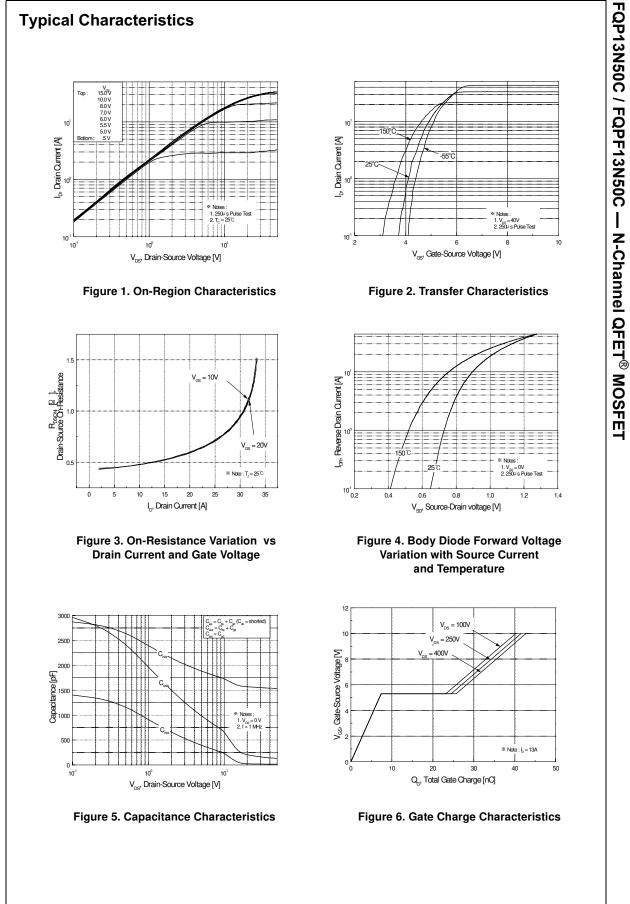
\* Drain current limited by maximum junction temperature

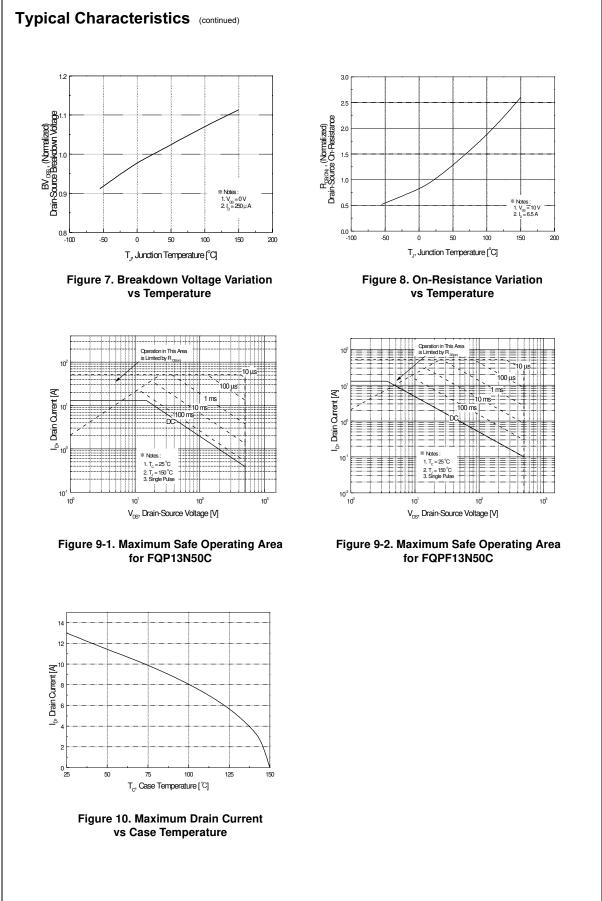
### **Thermal Characteristics**

Symbol	Parameter	FQP13N50C	FQPF13N50C	Units °C/W	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	0.64	2.58		
$R_{\theta JS}$	Thermal Resistance, Case-to-Sink, Typ.	0.5		°C/W	
$R_{\thetaJA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	62.5	°C/W	

 $\textcircled{\sc c}2003$  Semiconductor Components Industries, LLC. September-2017, Rev. 3

		Top Mark	Package		Packing Metho	d Reel	Size	Tape Width		Quantity	
		FQP13N50C TC	TO-2	220	Tube	N/	A	N/A		50 units	
		20F Tube N/		A	N/A		50 units				
lectri	cal Cha	racteristics <b>⊤</b>	<sub>c</sub> = 25°C unl	ess otherwi	se noted.			1			
Symbol		Parameter			Test Conditions		Min	Тур	Мах	Unit	
	rootoriot	ioo									
BV <sub>DSS</sub>	aracteristics Drain-Source Breakdown Voltage		V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA			500			V		
ABV <sub>DSS</sub>	Breakdown Voltage Temperature					500			v		
$\Delta T_{\rm I}$	Coefficient	<b>a</b> .		$I_D$ = 250 µA, Referenced to 25°C				0.5		V/°C	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current		V <sub>DS</sub> = 500 V, V <sub>GS</sub> = 0 V				1	μA			
			$V_{DS} = 400 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$					10	μΑ		
GSSF	Gate-Body	e-Body Leakage Current, Forward		$V_{GS} = 30 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$					100	nA	
GSSR	-	-Body Leakage Current, Reverse		V <sub>GS</sub> = -	30 V, V <sub>DS</sub> = 0 V				-100	nA	
				1			1	I	L		
	racteristi	cs						r			
V <sub>GS(th)</sub>	Gate Thre	shold Voltage		$V_{DS} = V$	/ <sub>GS</sub> , I <sub>D</sub> = 250 μA		2.0		4.0	V	
R <sub>DS(on)</sub>	Static Drai On-Resista			V <sub>GS</sub> = 7	0 V, I <sub>D</sub> = 6.5 A			0.39	0.48	Ω	
9 <sub>FS</sub>	Forward T	ransconductance		$V_{DS} = 4$	0 V, I <sub>D</sub> = 6.5 A			15		S	
C <sub>iss</sub>	ic Charac			V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1.0 MHz				1580	2055	pF	
C <sub>oss</sub>	Output Ca	pacitance						180	235	pF	
C <sub>rss</sub>	Reverse T	ransfer Capacitance	;					20	25	pF	
Switchi	ing Charg	otoriotioo									
	Turn-On D							25	60	20	
t <sub>d(on)</sub>	Turn-On R	-		V <sub>DD</sub> = 2	250 V, I <sub>D</sub> = 13 A,					ns	
tr t				R <sub>G</sub> = 28	δΩ			100 130	210 270	ns	
t <sub>d(off)</sub> t <sub>f</sub>	Turn-Off D			-		(Note 4)		100	210	ns	
հ Ծ								43	210 56	ns nC	
Q <sub>gs</sub>	Total Gate	ce Charge		20	00 V, I <sub>D</sub> = 13 A,			7.5		nC	
<u> </u>	Gate-Drain	•		V <sub>GS</sub> = 1	0 0	(Note 4)		18.5		nC	
Q <sub>gd</sub>	Gate-Drail	Tonarge				(1000-1)		10.0		110	
Drain-S	ource Di	ode Characteri	stics ar	nd Max	imum Ratings						
I <sub>S</sub>	Maximum	Continuous Drain-Source Diode Forward Current					13	Α			
SM	Maximum	Pulsed Drain-Source Diode Forward Current					52	А			
/ <sub>SD</sub>	Drain-Sou	rce Diode Forward \	/oltage	$V_{GS} = 0$	) V, I <sub>S</sub> = 13 A				1.4	V	
	Reverse R	ecovery Time		$V_{GS} = 0$	) V, I <sub>S</sub> = 13 A,			410		ns	
rr		ecovery Charge		di / dt	= 100 A/μs			4.5		μC	





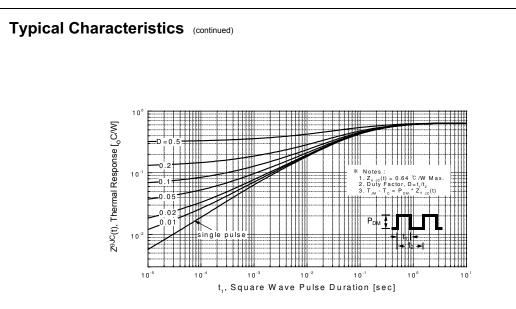


Figure 11-1. Transient Thermal Response Curve for FQP13N50C

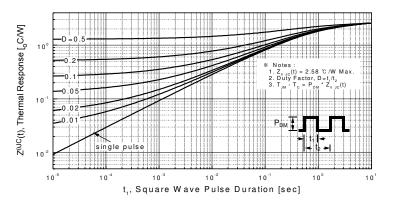
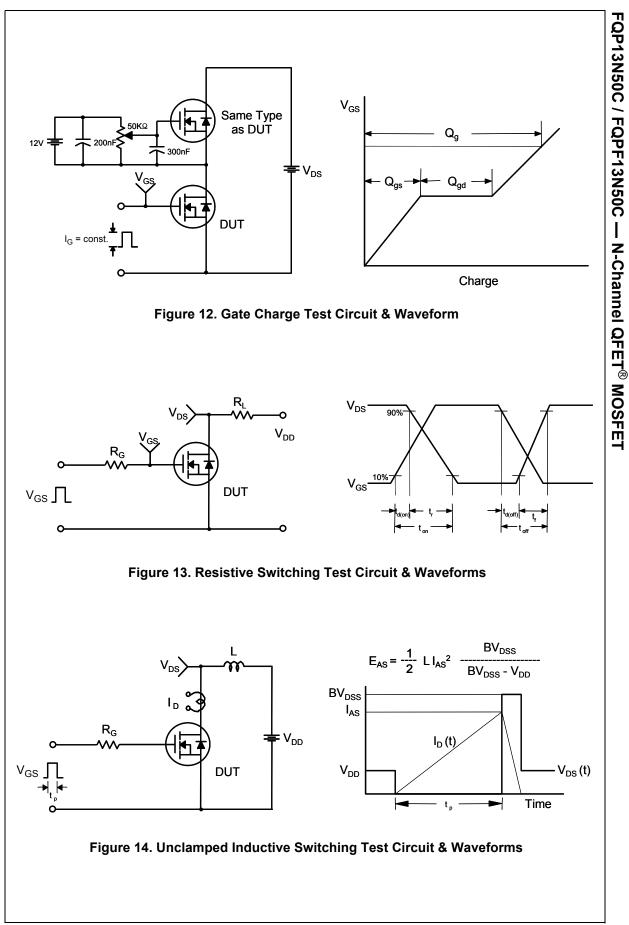
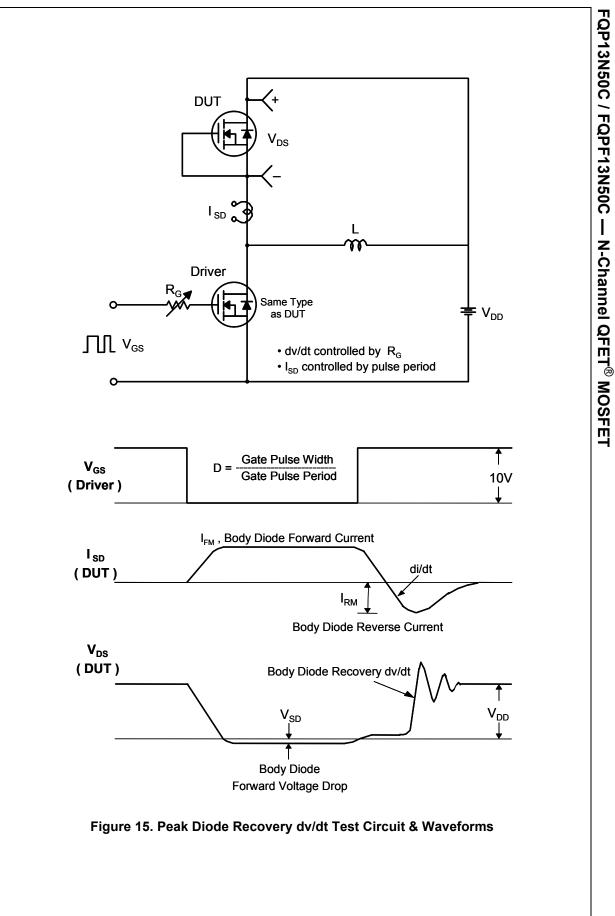
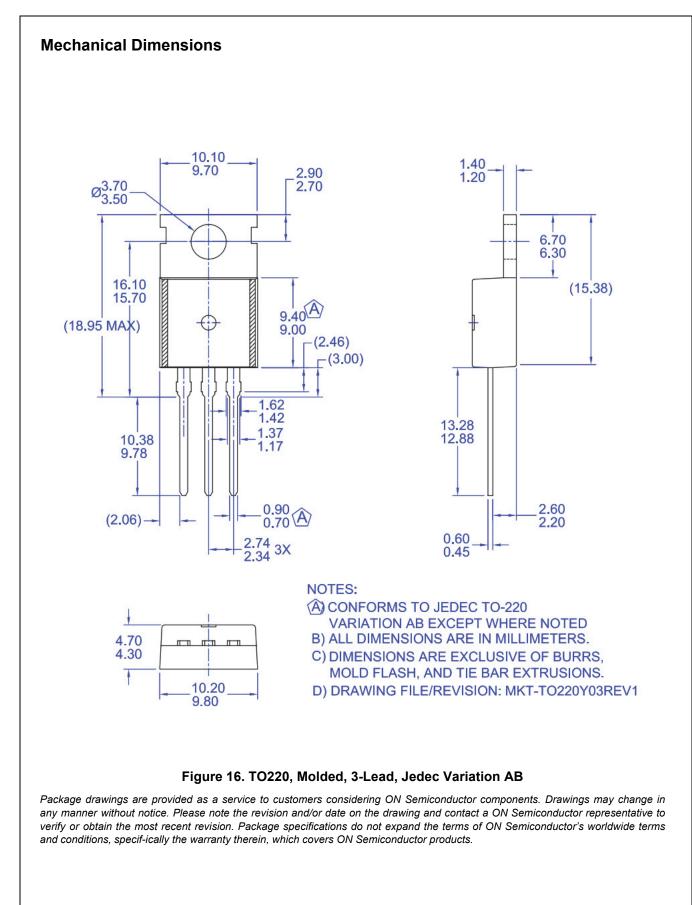
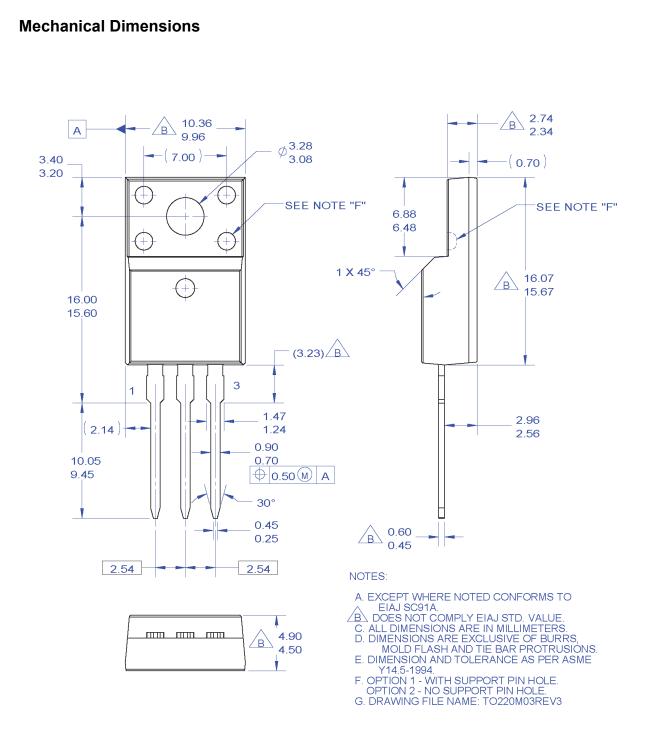


Figure 11-2. Transient Thermal Response Curve for FQPF13N50C









FQP13N50C / FQPF13N50C — N-Channel QFET<sup>®</sup> MOSFET

#### Figure 17. TO220, Molded, 3-Lead, Full Pack, EIAJ SC91, Straight Lead

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